

L Number	Hits	Search Text	DB	Time stamp
1	218104	(TAB or (tape adj circuit adj board))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 09:37
2	78196	((TAB or (tape adj circuit adj board))) and base	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 09:37
3	15983	((((TAB or (tape adj circuit adj board))) and base) and adhesive	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 09:37
4	1214	((((TAB or (tape adj circuit adj board))) and base) and adhesive) and (bump or bumps)	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27
5	897	(((((TAB or (tape adj circuit adj board))) and base) and adhesive) and (bump or bumps)) and (chip or IC or die)	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:05
6	2	("5801449").PN.	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:07
7	11	5801449.URPN.	USPAT	2003/12/02 10:06
8	7	("5045921" "5127570" "5203075" "5559316" "5600183" "5608262" "5616958").PN.	USPAT	2003/12/02 10:07
9	225	257/779-781.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:26
10	3	("6020637" "6028358" "6046495" "2001/0001505" "2001/0054768").PN.	USPAT	2003/12/02 10:09
11	266	174/261-264.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:19
12	234	174/254-258.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:20
13	69	(174/254-258.ccls. and ((TAB or (tape adj circuit adj board)))) and (bump or bumps)	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27
14	355	257/723-724.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:26
15	873	438/106-127.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27
16	426	(438/106-127.ccls. and ((TAB or (tape adj circuit adj board)))) and (bump or bumps)	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27
17	178	438/612-613.ccls. and ((TAB or (tape adj circuit adj board)))	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27
18	139	(438/612-613.ccls. and ((TAB or (tape adj circuit adj board)))) and (bump or bumps)	USPAT; EPO; JPO; DERWENT; USOCR	2003/12/02 10:27